

# FDP6N60ZU / FDPF6N60ZUT N-Channel MOSFET, FRFET 600V, 4.5A, $2\Omega$

### Features

- $R_{DS(on)} = 1.7\Omega$  (Typ.) @  $V_{GS} = 10V$ ,  $I_D = 2.25A$
- Low gate charge (Typ. 14.5nC)
- Low C<sub>rss</sub> ( Typ. 5pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

GDS

RoHS compliant



## Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



### **MOSFET Maximum Ratings** $T_C = 25^{\circ}C$ unless otherwise noted\*

TO-220

**FDP Series** 

Symbol	Parameter			FDP6N60ZU	FDPF6N60ZUT	Units	
V <sub>DSS</sub>	Drain to Source Voltage			600		V	
V <sub>GSS</sub>	Gate to Source Voltage			±30		V	
I <sub>D</sub>	Drain Current	-Continuous ( $T_C = 25^{\circ}C$ )		4.5	4.5*		
		-Continuous ( $T_C = 100^{\circ}C$ )		2.7	2.7*	A	
I <sub>DM</sub>	Drain Current	- Pulsed		18	18*	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	150		mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	4.5		А	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	10.5		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns	
P <sub>D</sub>	Power Dissipation	$(T_{C} = 25^{\circ}C)$		105	33.8	W	
		- Derate above 25°C		0.85	0.27	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C	

### Thermal Characteristics

Symbol	Parameter	FDP6N60ZU	FDPF6N60ZUT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	3.7	
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ.		-	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

April 2012

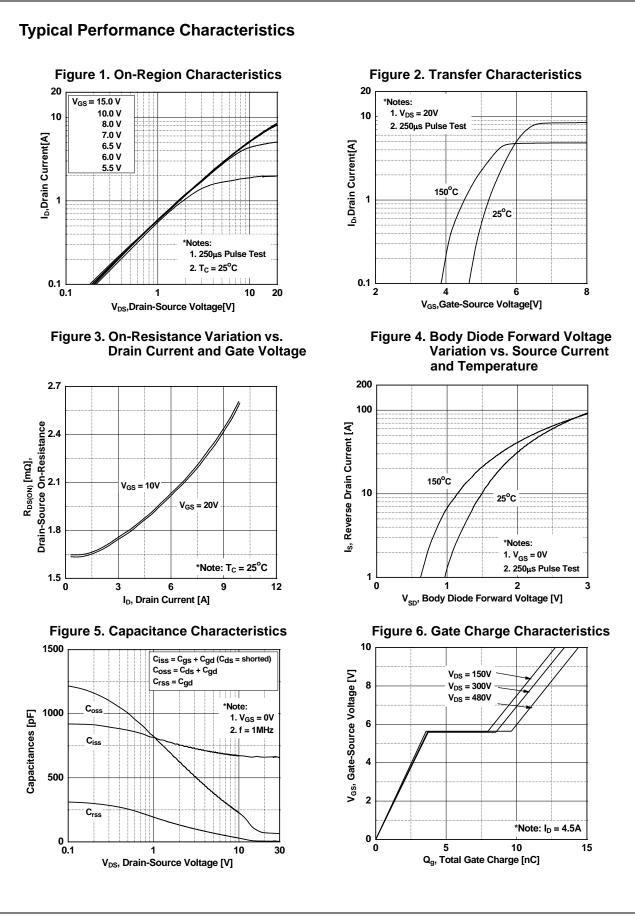
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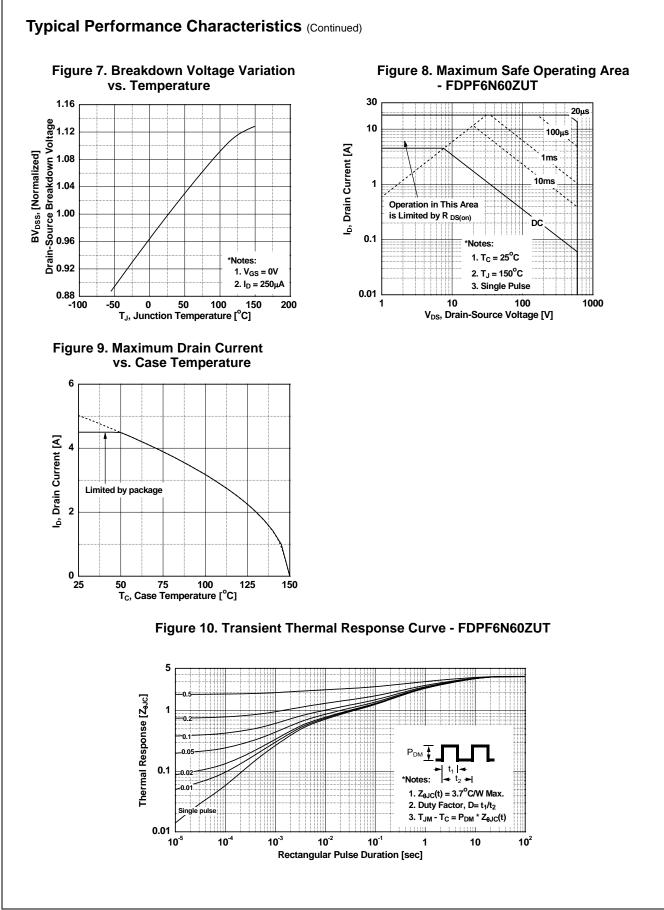
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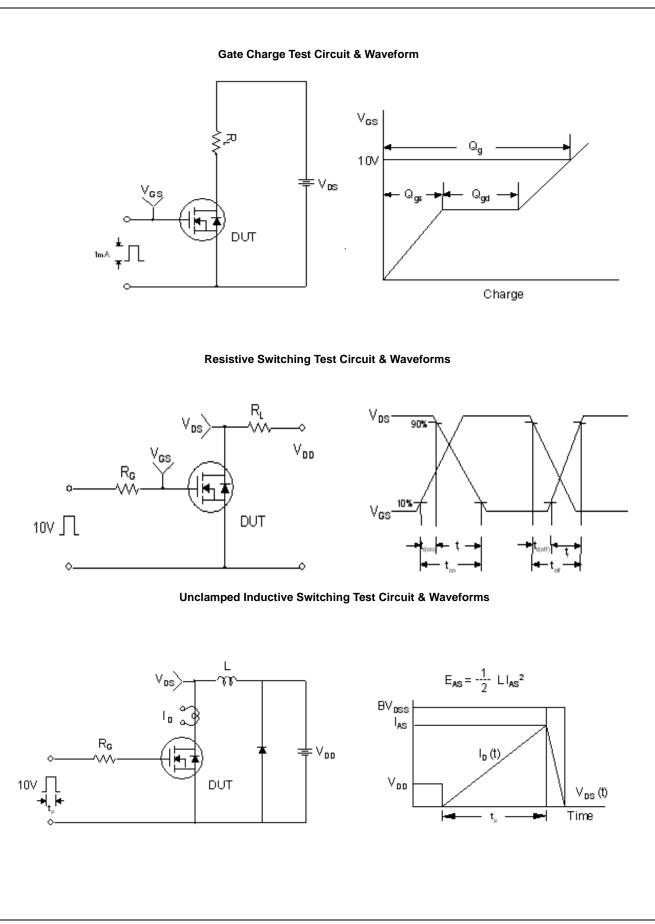
Device with	arking	Device	Packa	ge	Reel Size	Таре	e Width		Quanti	ty
		TO-22	20	-		-		50	•	
FDPF6N60ZUT FDPF6N60ZUT TO-2		TO-22	0F	-		-		50		
Electrica	l Char	actoristics T	25°C unloss	othonwig	o noted					
Symbol		Parameter			Test Conditions	ns Min.		Тур.	Max.	Unit
Off Charac	teristic	S				I		,,	1	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		$I_D = 250 \mu A, V_{GS} = 0V, T_J = 25^{\circ}C$		600	-	-	V		
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		$I_D = 250\mu$ A, Referenced to $25^{\circ}$ C		-	0.75	-	V/ºC		
	Zero Gate Voltage Drain Current		nt	$V_{DS} = 0$	600V, V <sub>GS</sub> = 0V		-	-	25	
DSS	2010 0		51 IL	$V_{DS} = 480V, T_{C} = 125^{\circ}C$			-	-	250	μΑ
GSS	Gate to	Body Leakage Curren	t	$V_{GS} =$	±30V, V <sub>DS</sub> = 0V		-	-	±10	μA
On Charac	teristic	S								
V <sub>GS(th)</sub>		ate Threshold Voltage		V <sub>GS</sub> =	/ <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		3.0	-	5.0	V
R <sub>DS(on)</sub>	Static I	atic Drain to Source On Resistance			$V_{GS} = 10V, I_D = 2.25A$			1.7	2.0	Ω
9FS	Forward Transconductance		$V_{DS} = 40V, I_D = 2.25A$			-	3.5	-	S	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Output	Reverse Transfer Capacitance f   Total Gate Charge at 10V f		- V <sub>DS</sub> = f = 1M	25V, V <sub>GS</sub> = 0V Hz	_	-	650 75 5	865 100 10	pF pF pF
Q <sub>g</sub>							_	14.5	20	nC
∝ <sub>g</sub> Q <sub>gs</sub>				V <sub>DS</sub> = 480V, I <sub>D</sub> = 4.5A		-	4	-	nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		V <sub>GS</sub> = 10V (Note 4)		-	6	-	nC		
Switching	Charac	teristics				<u>+</u>				
d(on)		Turn-On Delay Time					-	19	48	ns
-()	Turn-O	n Rise Time		V <sub>DD</sub> = 300V, I <sub>D</sub> = 4.5A		_	-	25	60	ns
d(off)	Turn-O	ff Delay Time		R <sub>G</sub> = 2	5Ω, V <sub>GS</sub> = 10V	_	-	25	60	ns
<sup>t</sup> f	Turn-O	f Fall Time		(Note 4)		(Note 4)	-	45	100	ns

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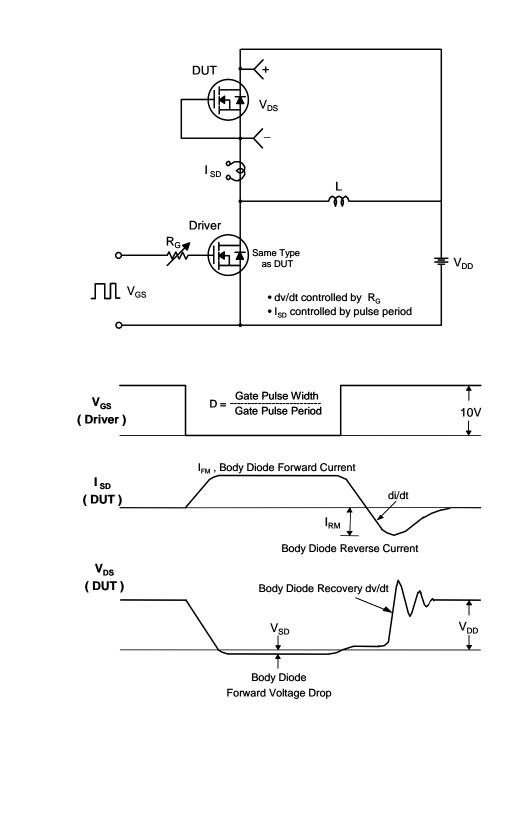


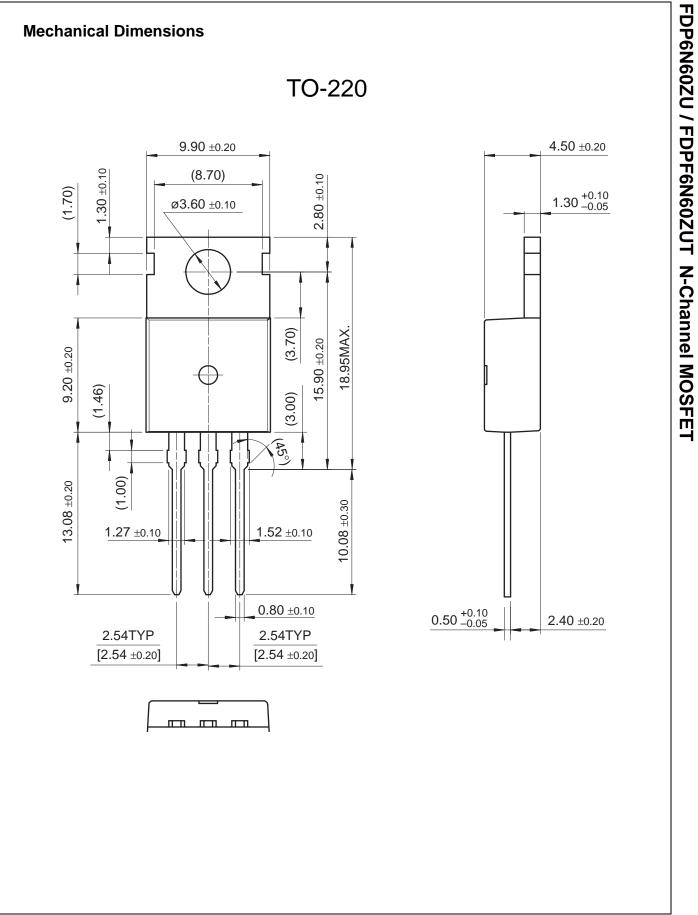


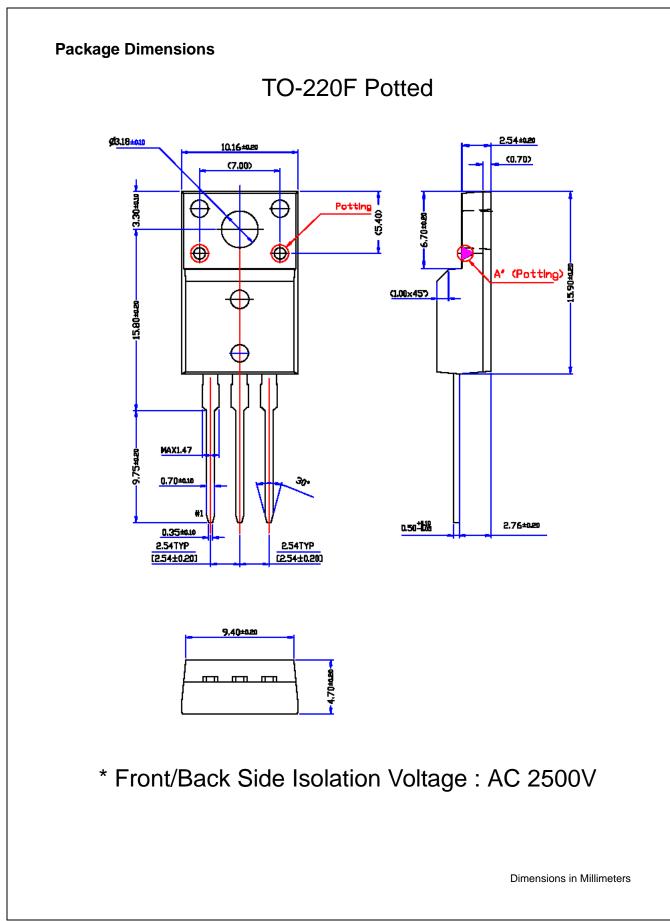


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Peak Diode Recovery dv/dt Test Circuit & Waveforms









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